



Product Summary

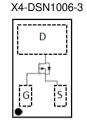
BV _{DSS}	RDS(ON) Max	I _{D Max} Ta = +25°C
-20V	78mΩ @ V _{GS} = -8V	-4.0A
-20V	$100m\Omega @ V_{GS} = -4.5V$	-3.5A

Description

This new generation MOSFET is designed to minimize the footprint in handheld and Mobile application. It can be used to replace many small signals MOSFET with as really small footprint.

Applications

- Battery Management
- Load Switch
- Battery Protection
- Handheld and Mobile Application



Top View

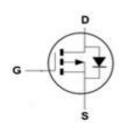
P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low Qg & Qgd
- Small Footprint
- Low Profile 0.20mm Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: X4-DSN1006-3
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu or NiAu. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.00029 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2077UCA3-7	X4-DSN1006-3	10k/Tape & Reel
DMP2077UCA3-7A	X4-DSN1006-3	10k/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Q = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: H = 2020) M or \overline{M} = Month (ex: 9 = September)

Date Code Key

Year	2018		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	F		Н		J	K	L	М	Ν	0	Р	R
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-20	V		
Gate-Source Voltage			VGSS	±12	V
Continuous Drain Current (Note 5) V _{GS} = -8V	Steady State	T _A = +25°C T _A = +70°C	D	-4.0 -3.2	А
Continuous Drain Current (Note 5) V _{GS} = -4.5V	ID	-3.5 -2.8	A		
Pulsed Drain Current (Note 6)			Ідм	-16	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	0.66	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 7)	Reja	197	°C/W
Power Dissipation (Note 5)	PD	1.98	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	Reja	65	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

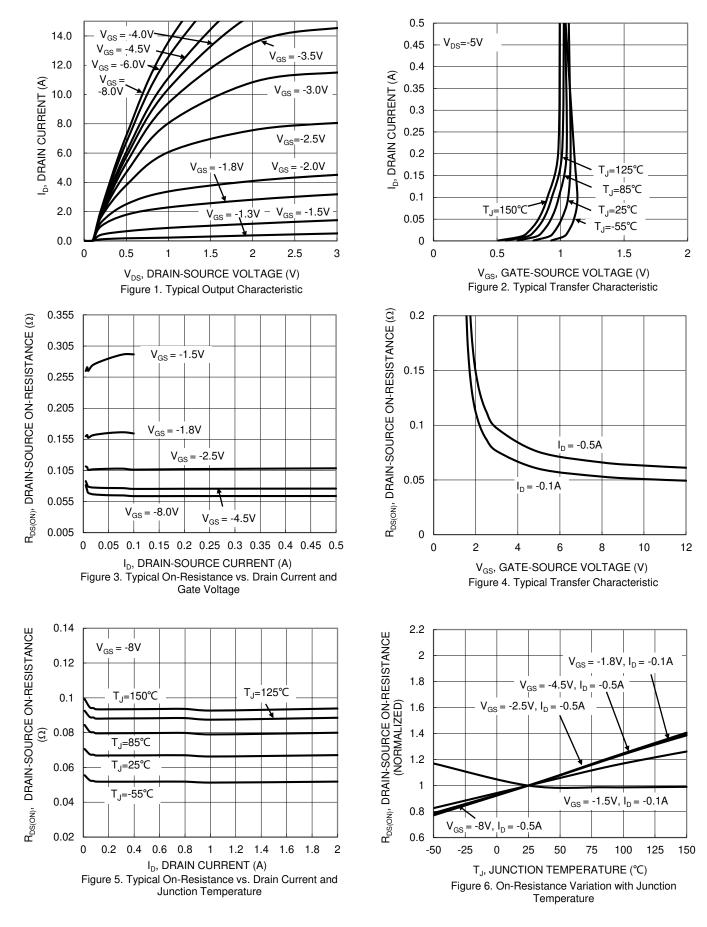
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BVDSS	-20	—	_	V	$V_{GS} = 0V, I_D = -250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	—	—	-100	nA	$V_{DS} = -16V, V_{GS} = 0V$		
Gate-Source Leakage	lgss	_	—	±50	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	VGS(TH)	-0.5	-0.85	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$		
			66	78		$V_{GS} = -8V, I_{D} = -0.5A$		
		_	78	100		$V_{GS} = -4.5V, I_{D} = -0.5A$		
Static Drain-Source On-Resistance	RDS(ON)	_	112	165	mΩ	$V_{GS} = -2.5V, I_{D} = -0.5A$		
		_	165	600		$V_{GS} = -1.8V, I_{D} = -0.1A$		
			295	900		V _{GS} = -1.5V, I _D = -0.1A		
Diode Forward Voltage	Vsd	-	-0.73	-1.0	V	V _{GS} = 0V, I _S = -0.5A		
Reverse Recovery Charge	QRR	-	1.3	_	nC	V _{DD} = -10V, I _F = -1A,		
Reverse Recovery Time	trr		7.7		ns	di/dt = 100A/µs		
DYNAMIC CHARACTERISTICS (Note 9)			•	•		·		
Input Capacitance	Ciss	_	143					
Output Capacitance	Coss	_	76	_	pF	$V_{DS} = -10V$, $V_{GS} = 0V$, f = 1MHz		
Reverse Transfer Capacitance	Crss	_	3.2	_		T = TMHZ		
Series Gate Resistance	Rg	_	4.7	_	Ω	$f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$		
Total Gate Charge	Qg		1.34					
Gate-Source Charge	Q _{gs}		0.12		nC	$V_{GS} = -4.5V, V_{DS} = -10V,$		
Gate-Drain Charge	Q _{gd}		0.15		nc	I _D = -0.5A		
Gate Charge at VTH	Qg(TH)		0.24					
Turn-On Delay Time	tD(ON)	_	15.4	_				
Turn-On Rise Time	t _R	_	5.7	_		V _{DS} = -10V, V _{GS} = -4.5V,		
Turn-Off Delay Time	tD(OFF)	_	5.8	_	ns	$R_g = 2\Omega$, $I_D = -0.5A$		
Turn-Off Fall Time	tF	_	5.4	_	1	,		

Notes:

Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
Repetitive rating, pulse width limited by junction temperature.
Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

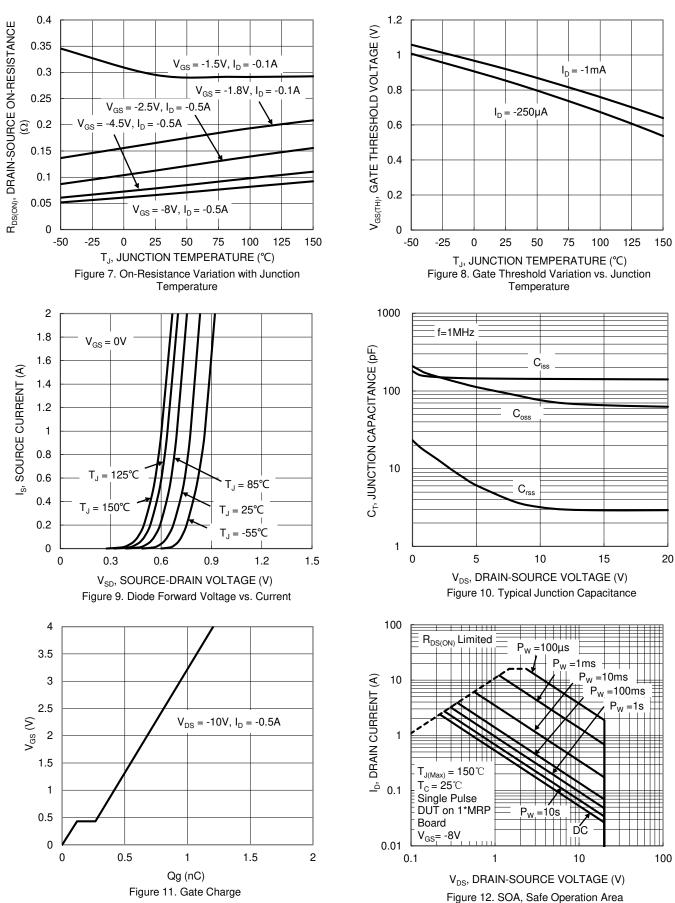


DMP2077UCA3



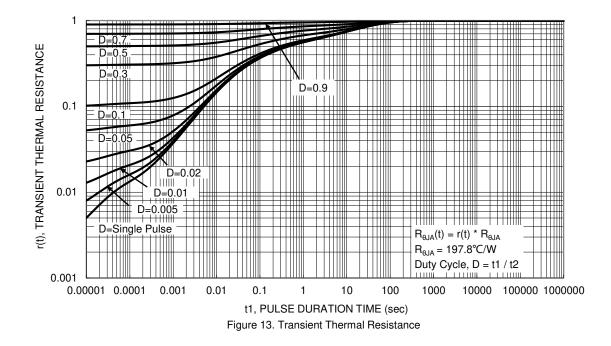


DMP2077UCA3



DMP2077UCA3 Document number: DS41537 Rev. 3 - 2



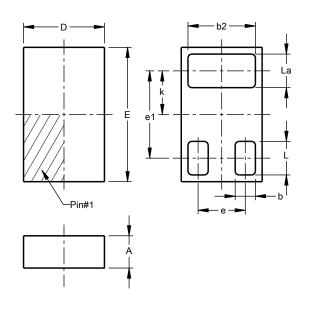




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X4-DSN1006-3

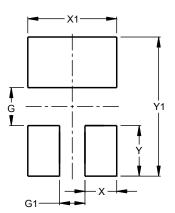


	X4-DSN1006-3							
Dim	Min	Max	Тур					
Α	0.18	0.22	0.20					
b	0.14	0.16	0.15					
b2	0.49	0.51	0.50					
D	0.56	0.64	0.60					
Е	0.96	1.04	1.00					
е			0.35					
e1			0.65					
k			0.325					
L	0.24	0.26	0.25					
La	0.24	0.26	0.25					
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X4-DSN1006-3



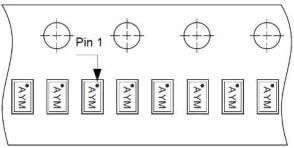
Dimensions	Value (in mm)		
G	0.40		
G1	0.20		
Х	0.15		
X1	0.50		
Y	0.25		
Y1	0.90		



Tape and Reel Information

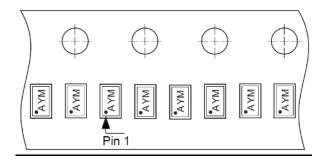
Please see https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf for the latest version.

DMP2077UCA3-7



DMP2077UCA3-7A

Change the PIN1 orientation in the carrier tape, rotate 180 degrees (Top side).





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